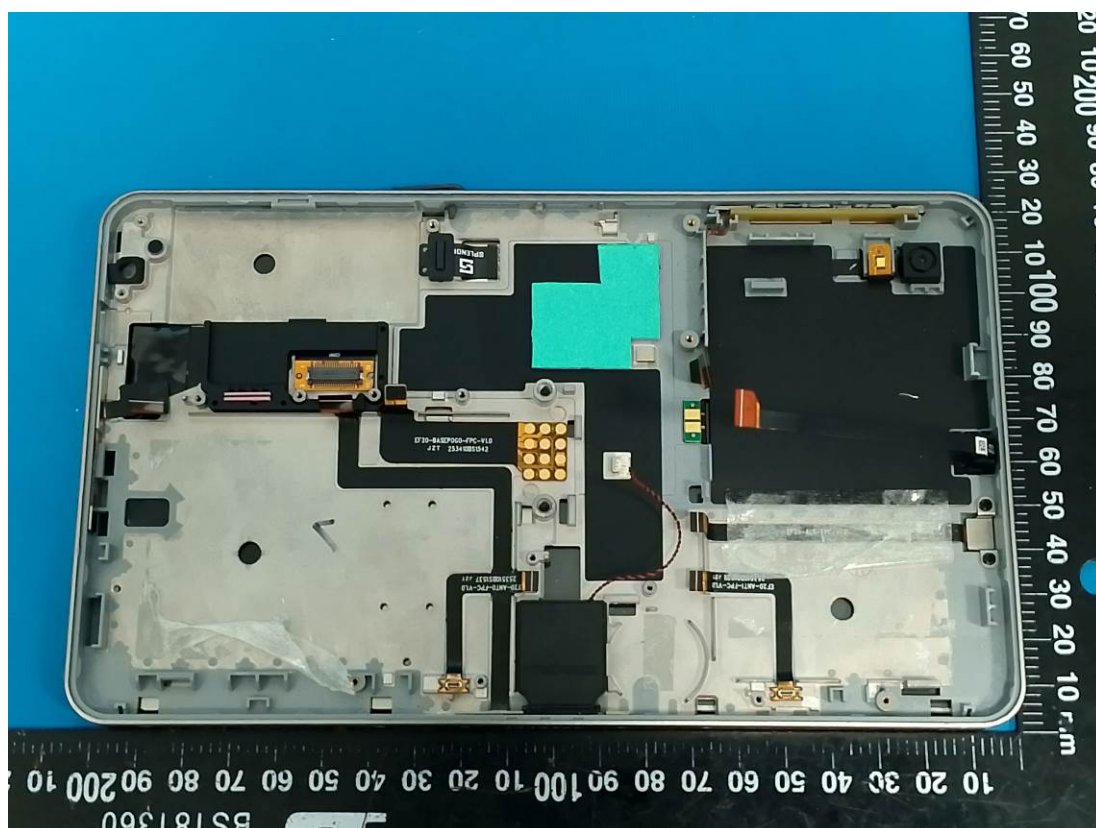
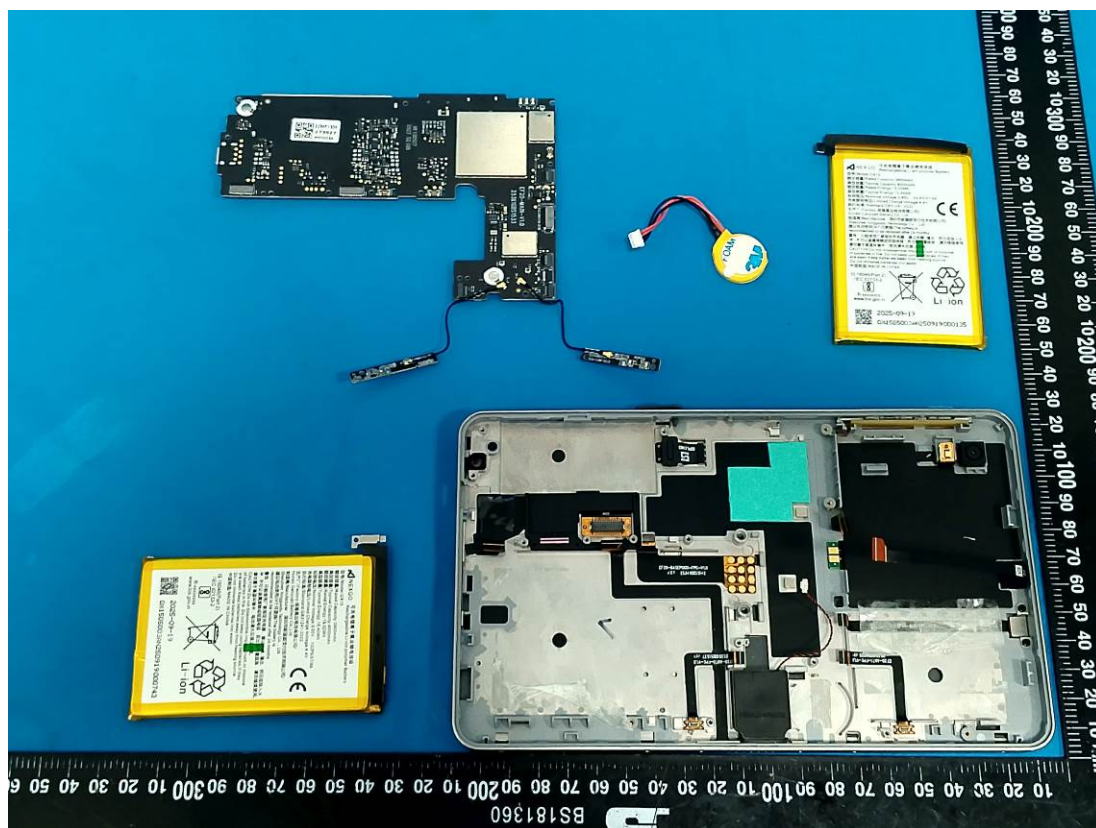
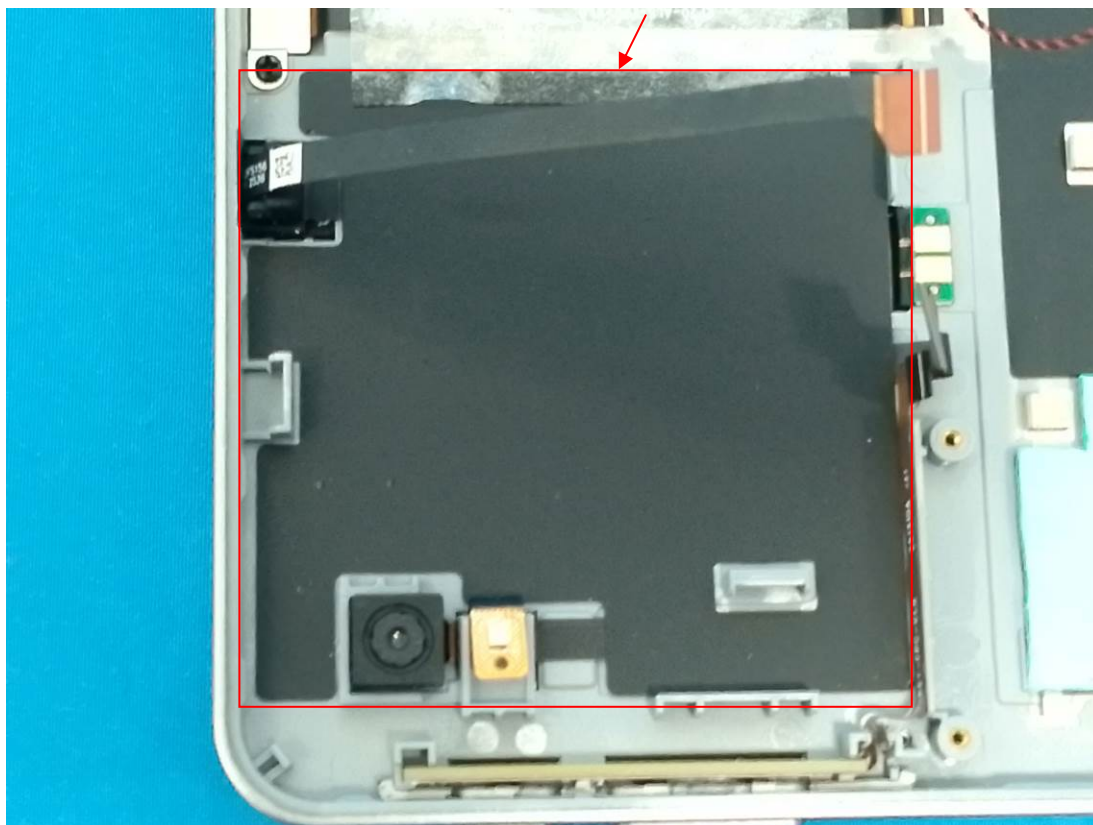


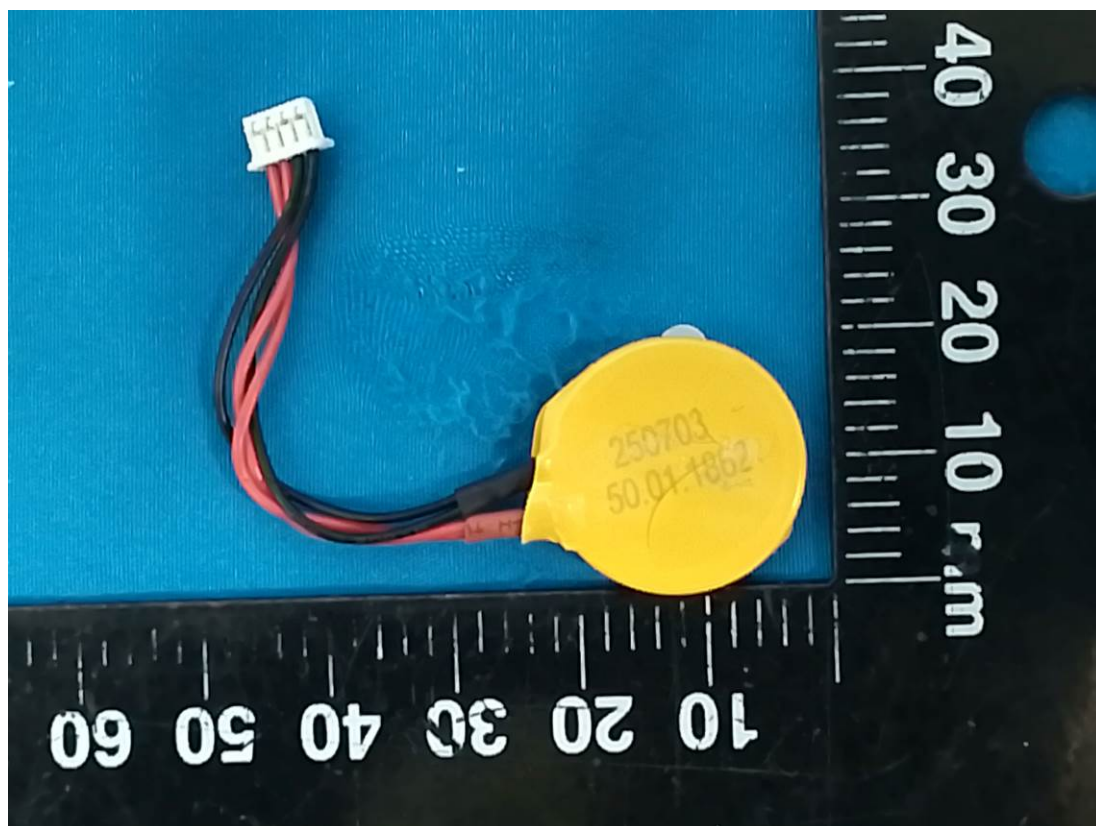


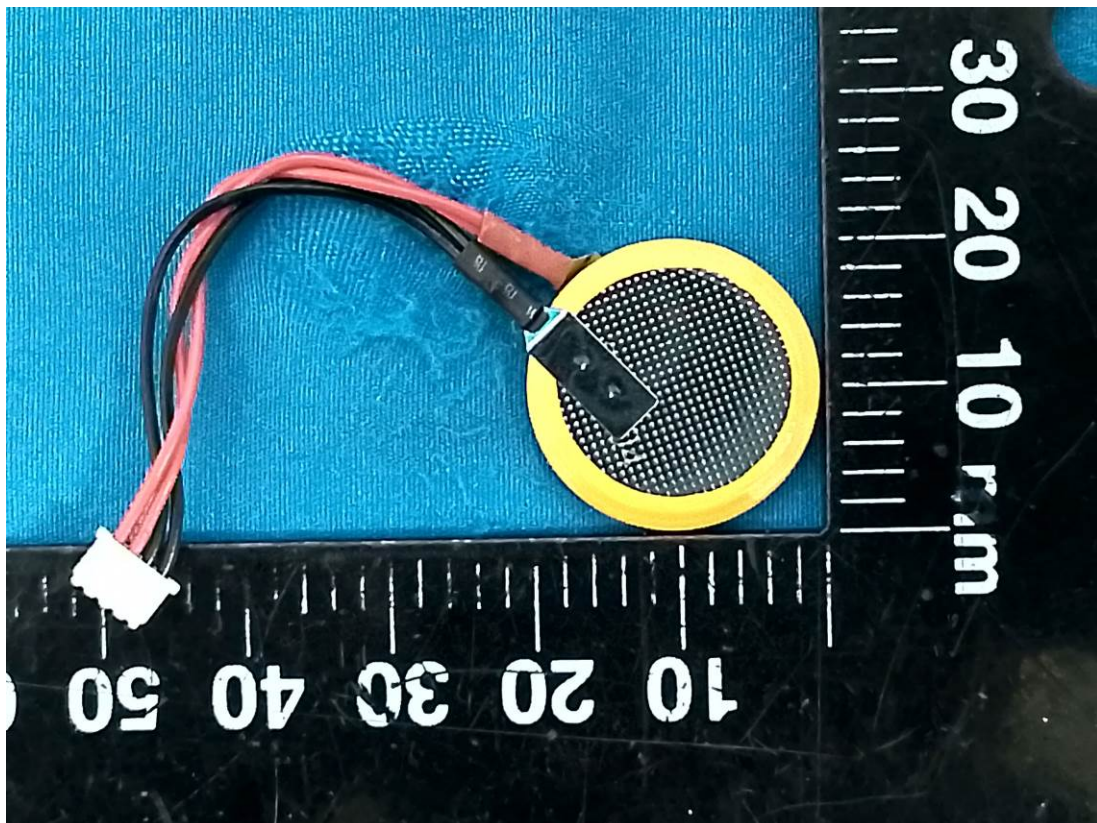
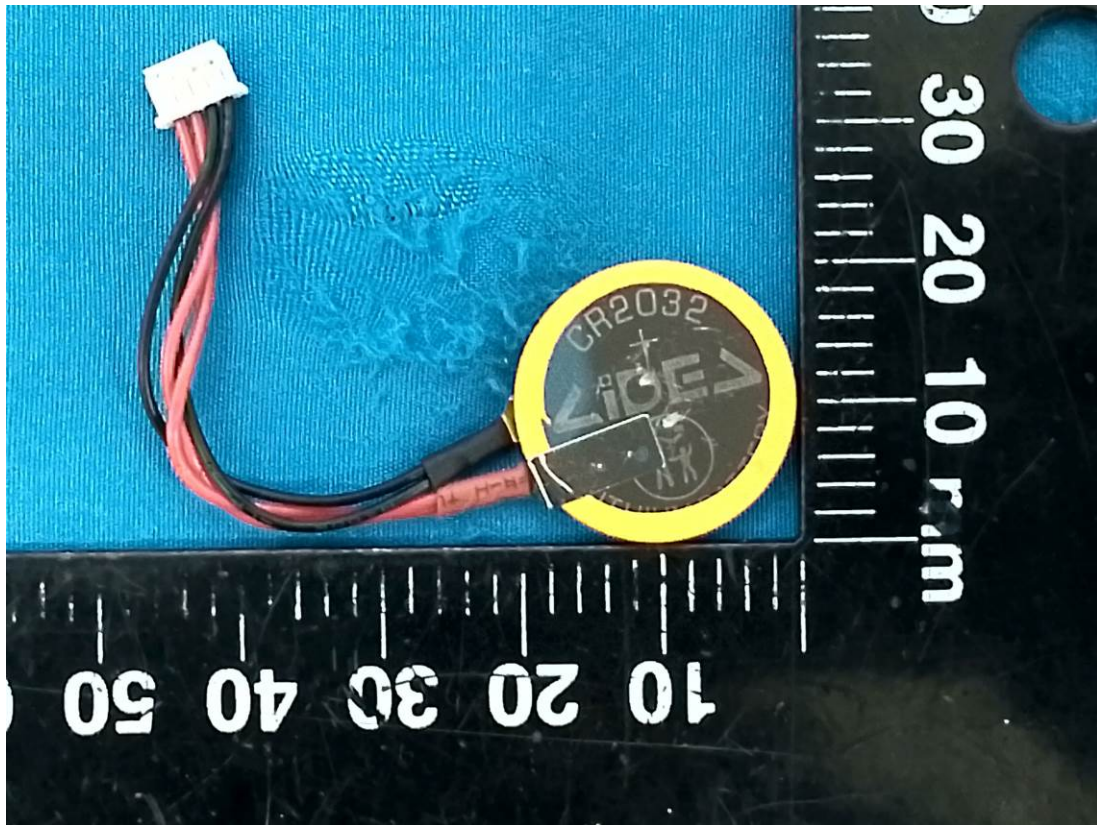
NFC Antenna(ANT 3)

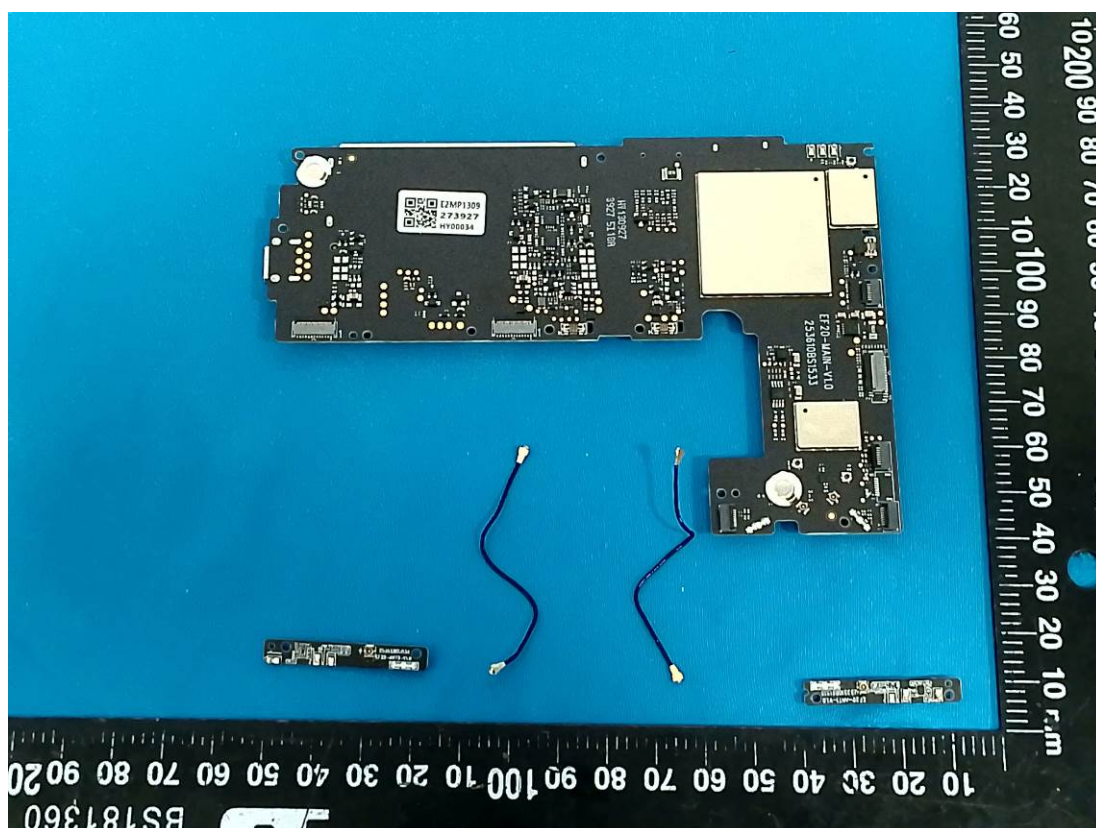
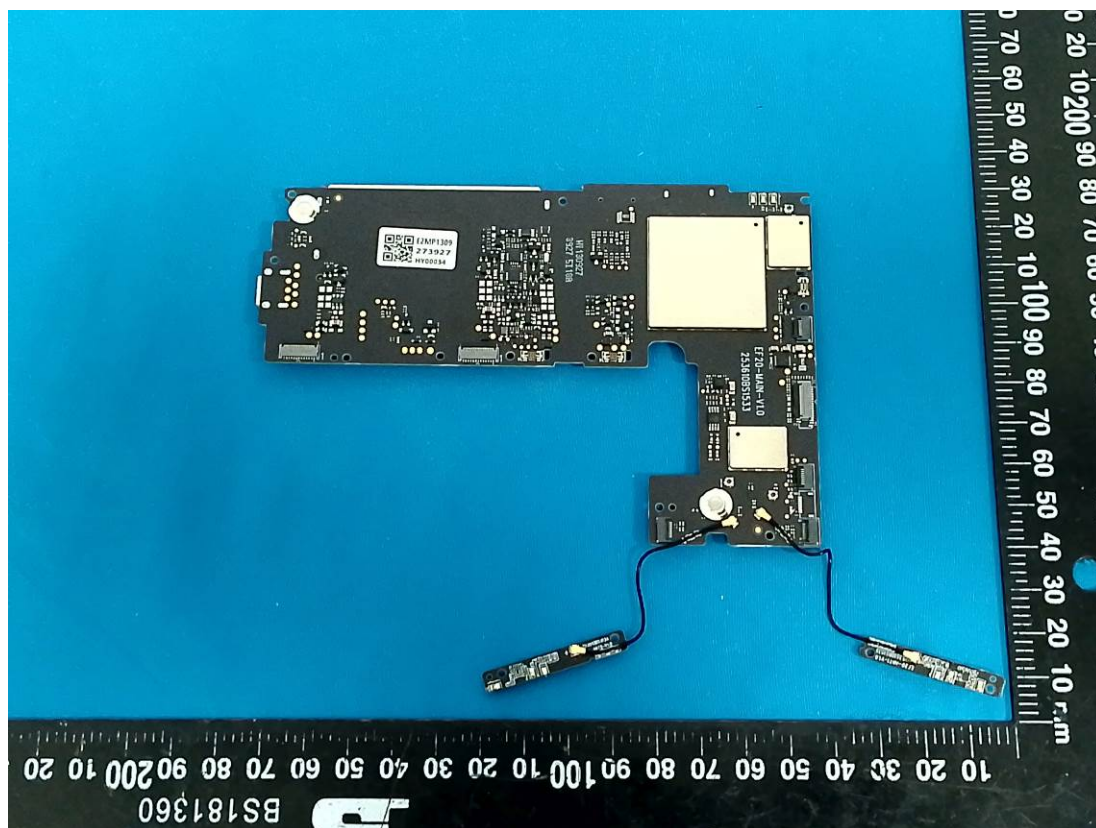


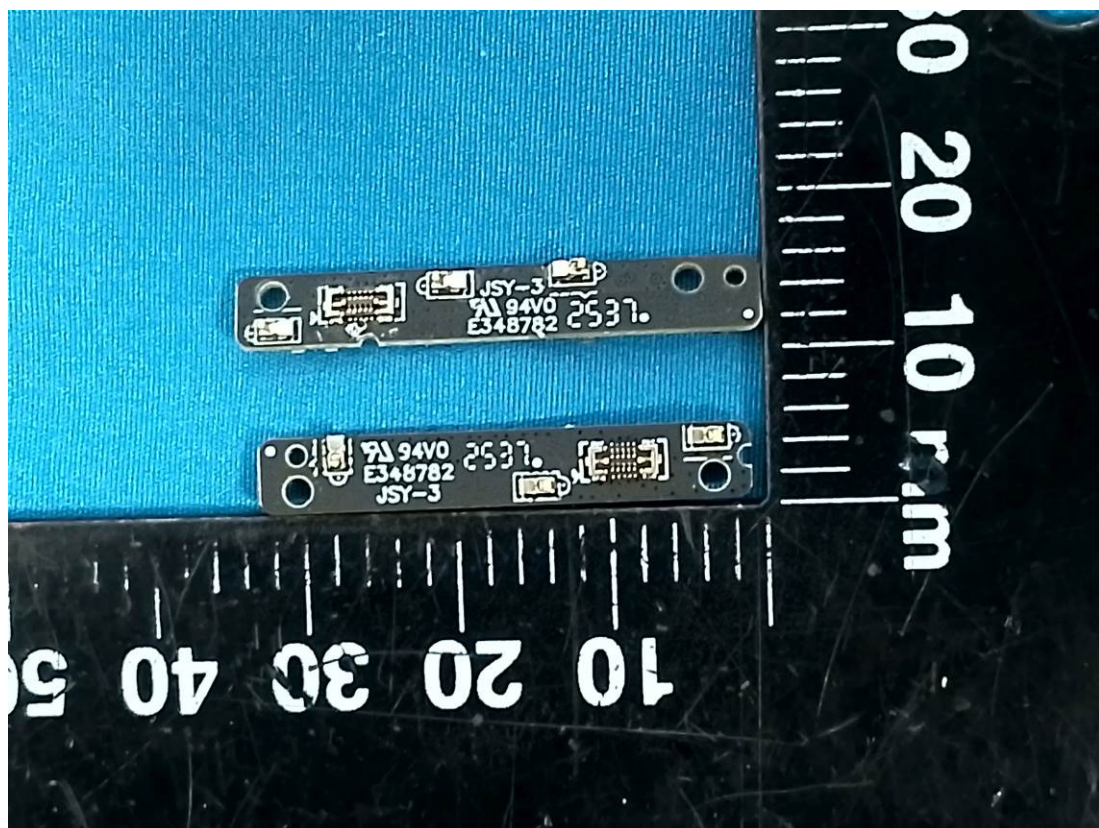
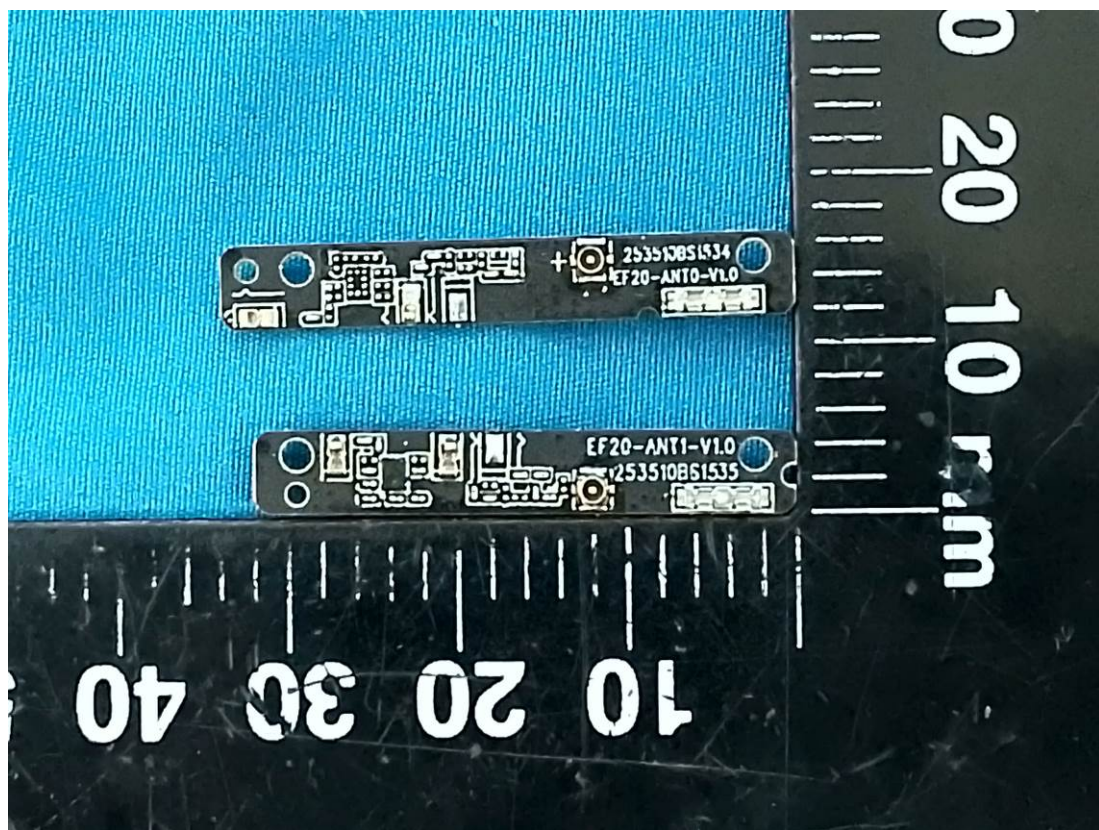
Dual battery

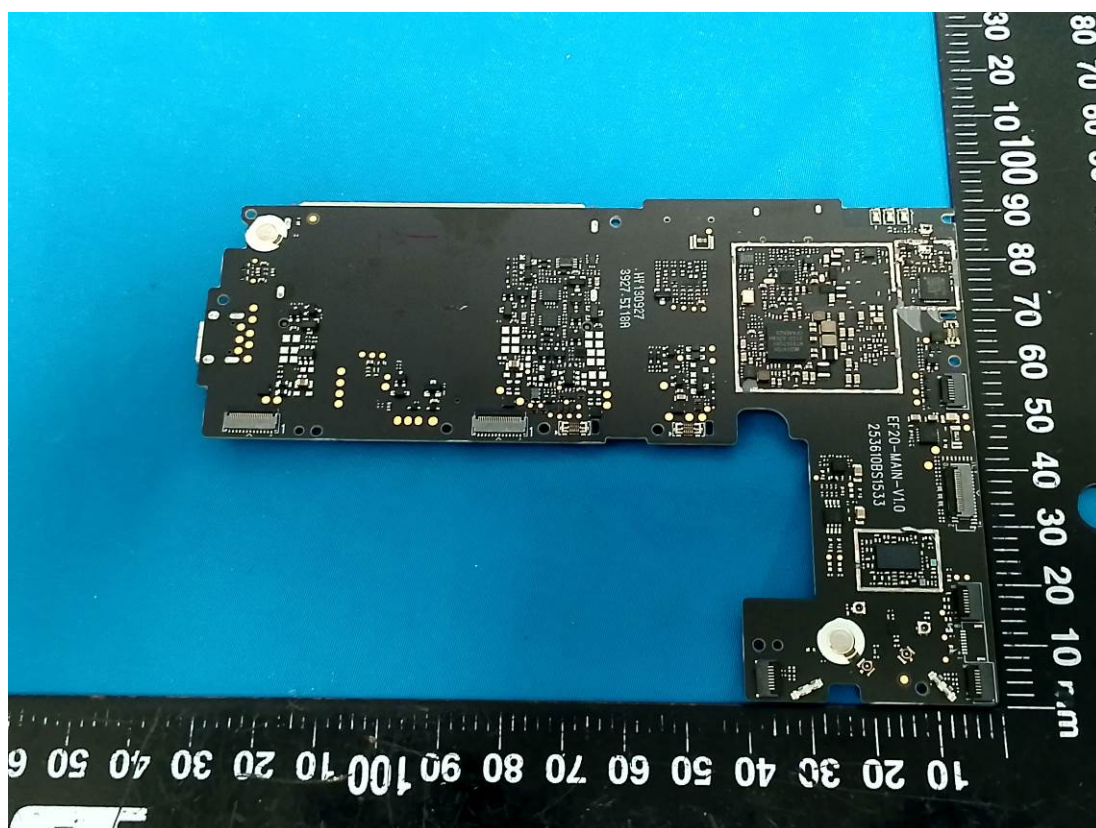
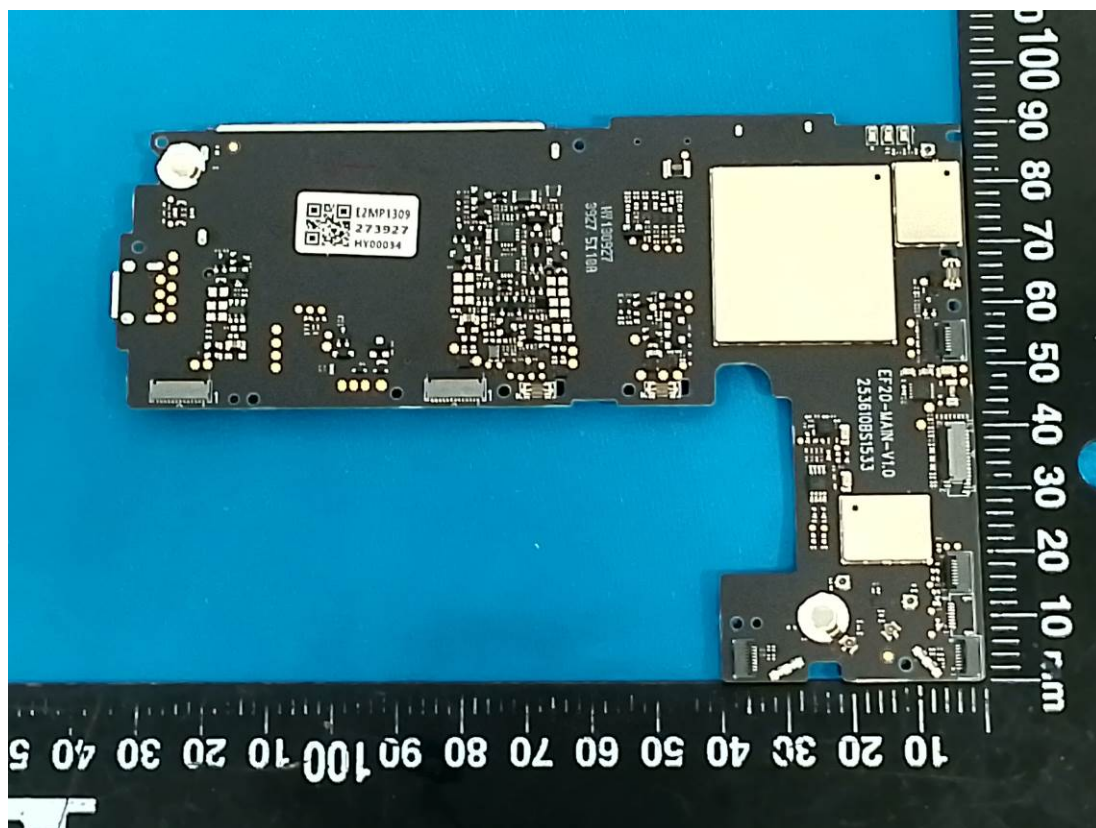


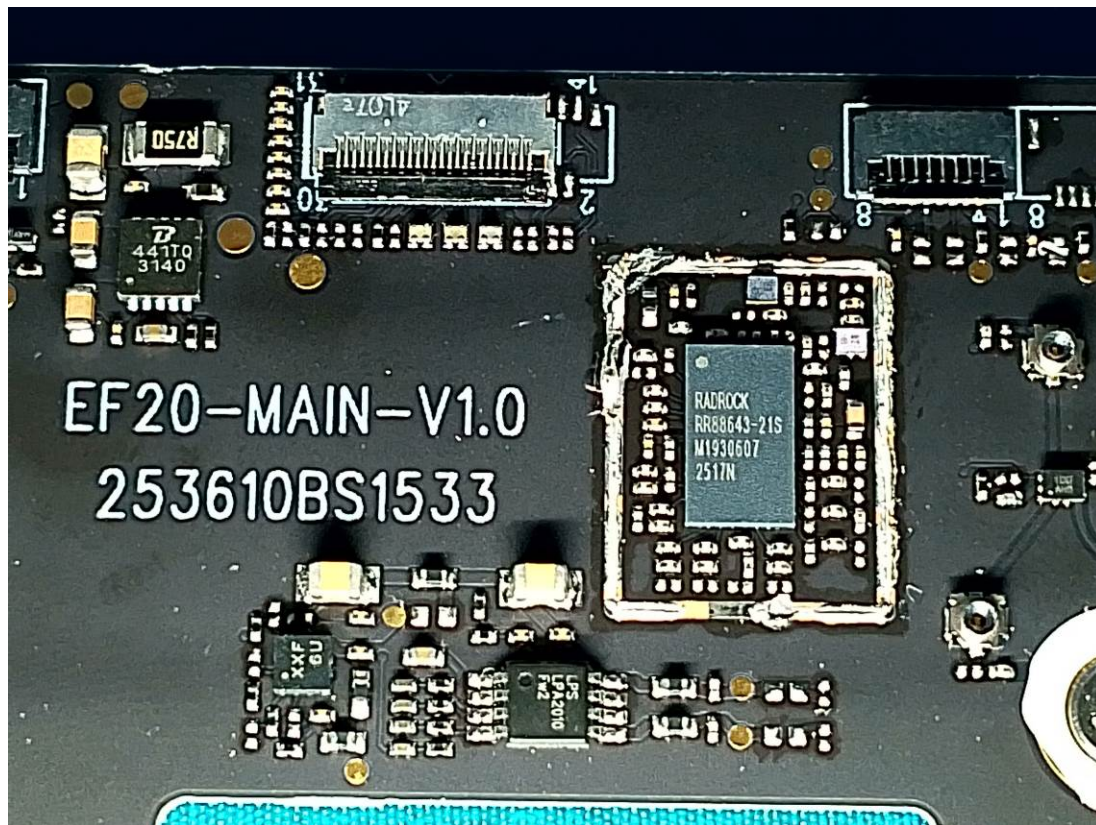




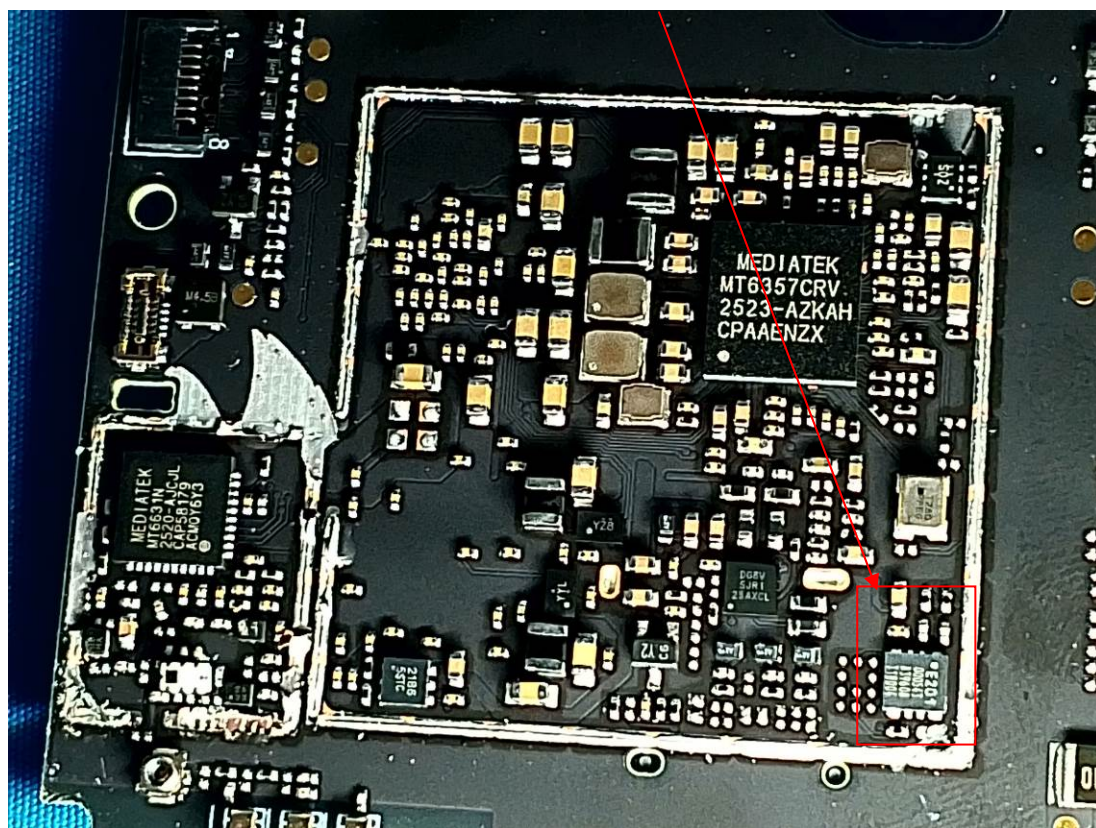


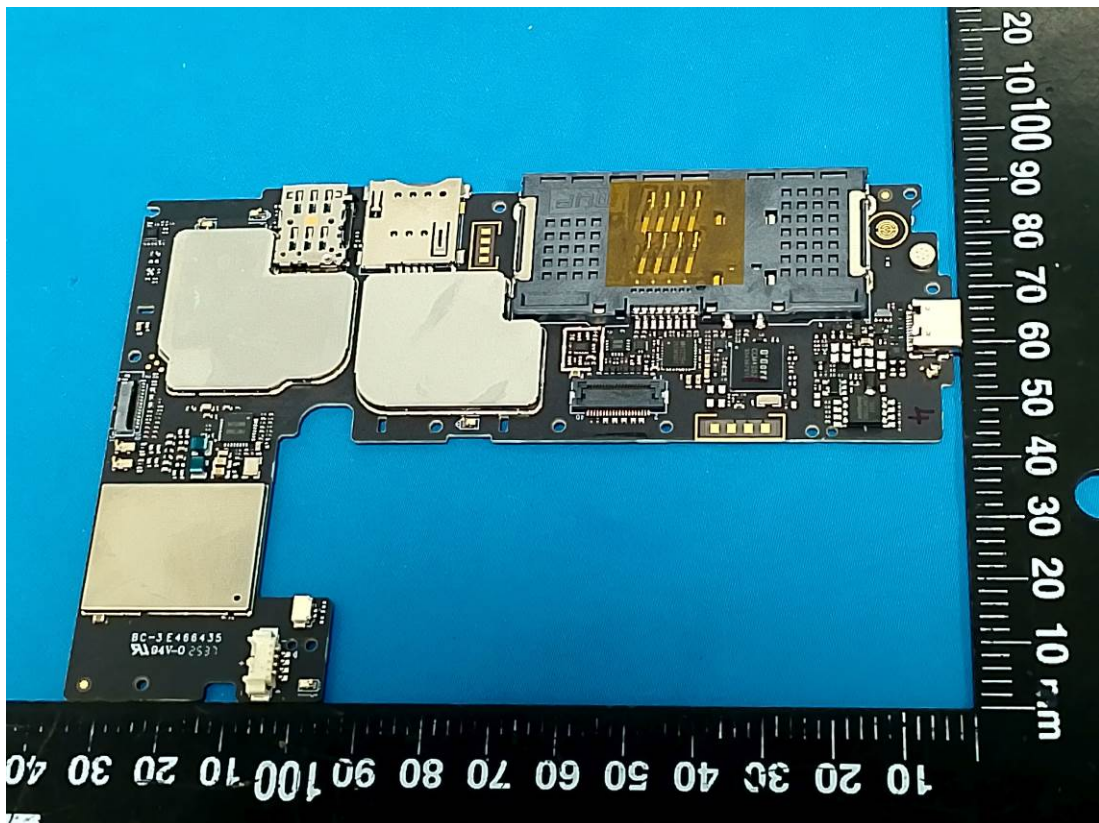
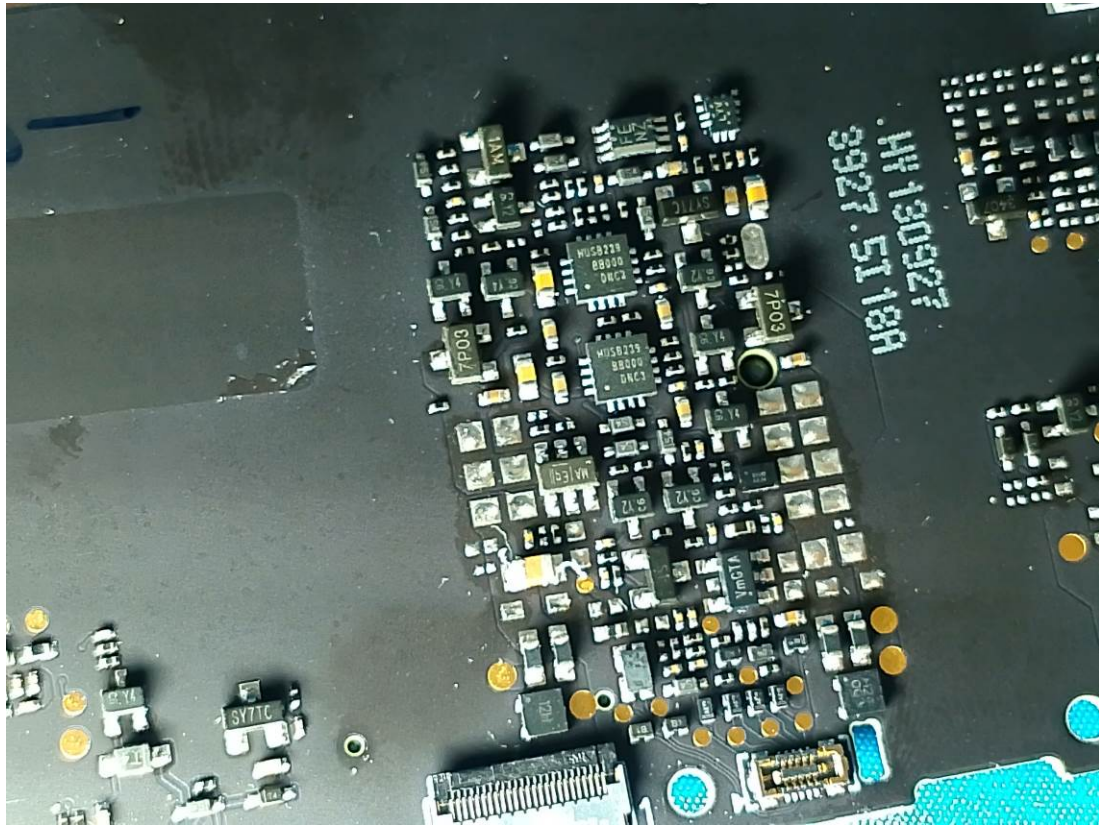


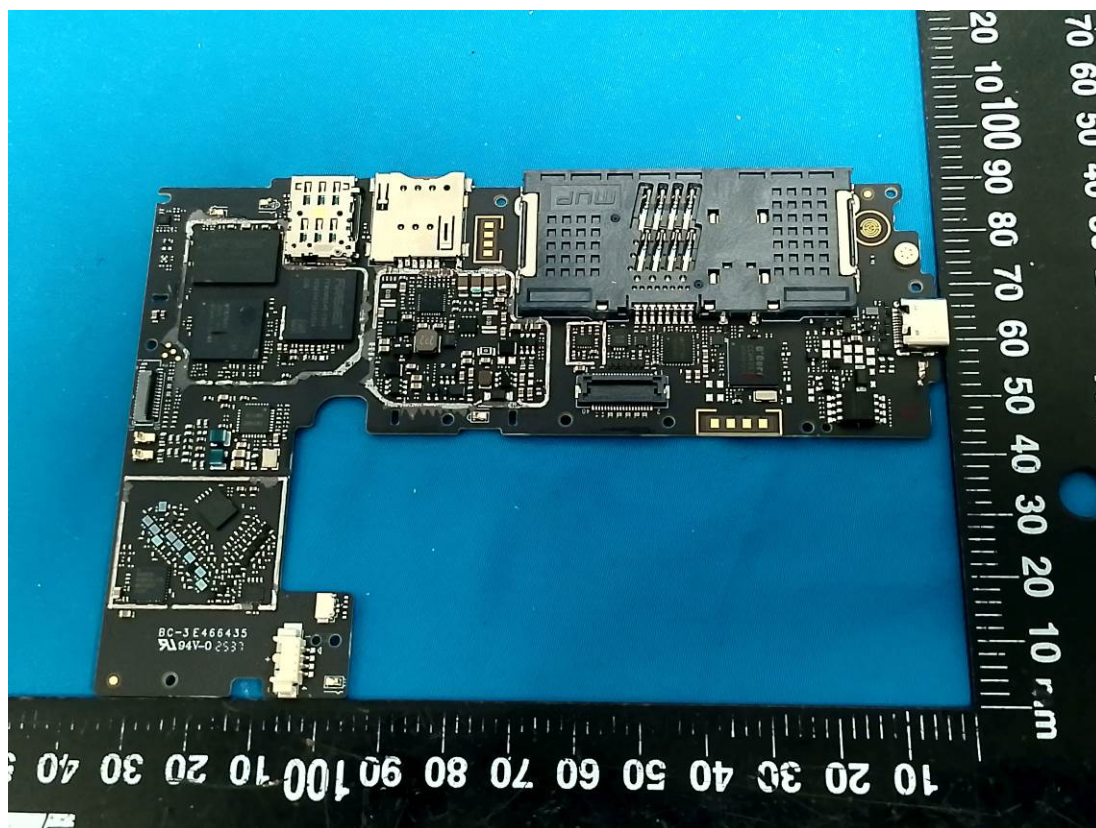




It is pasted with eSIM

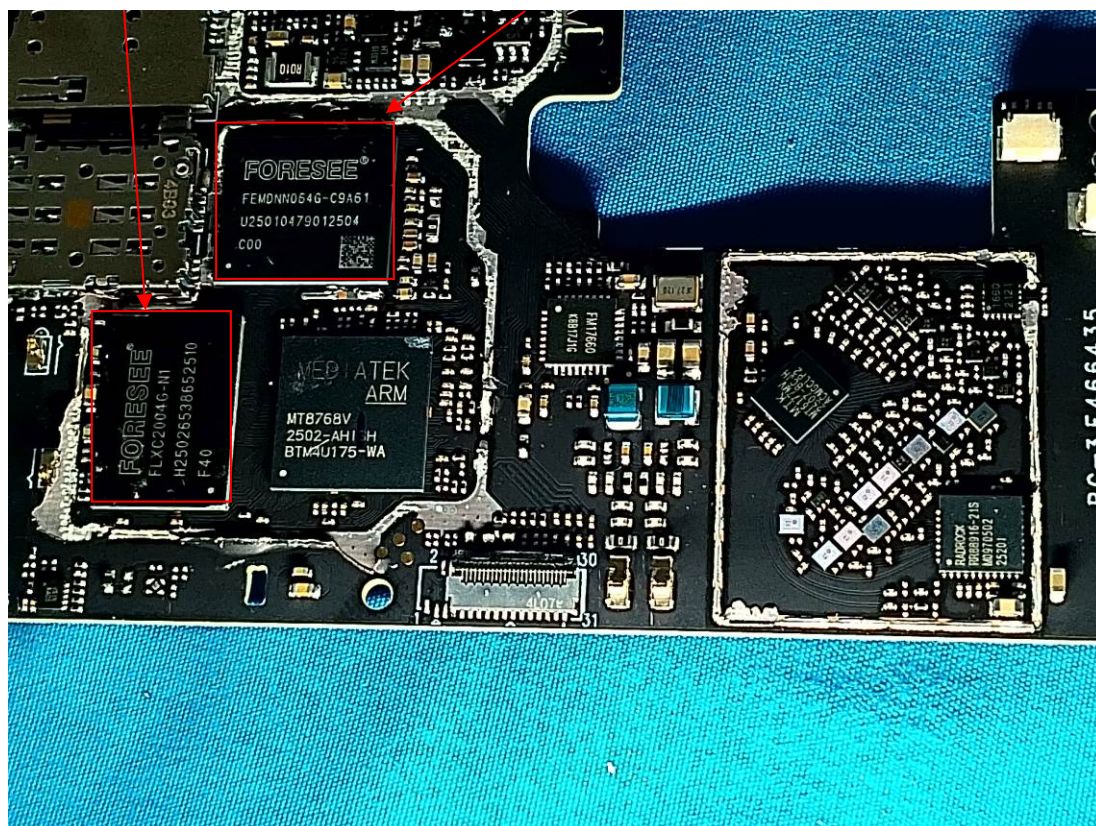




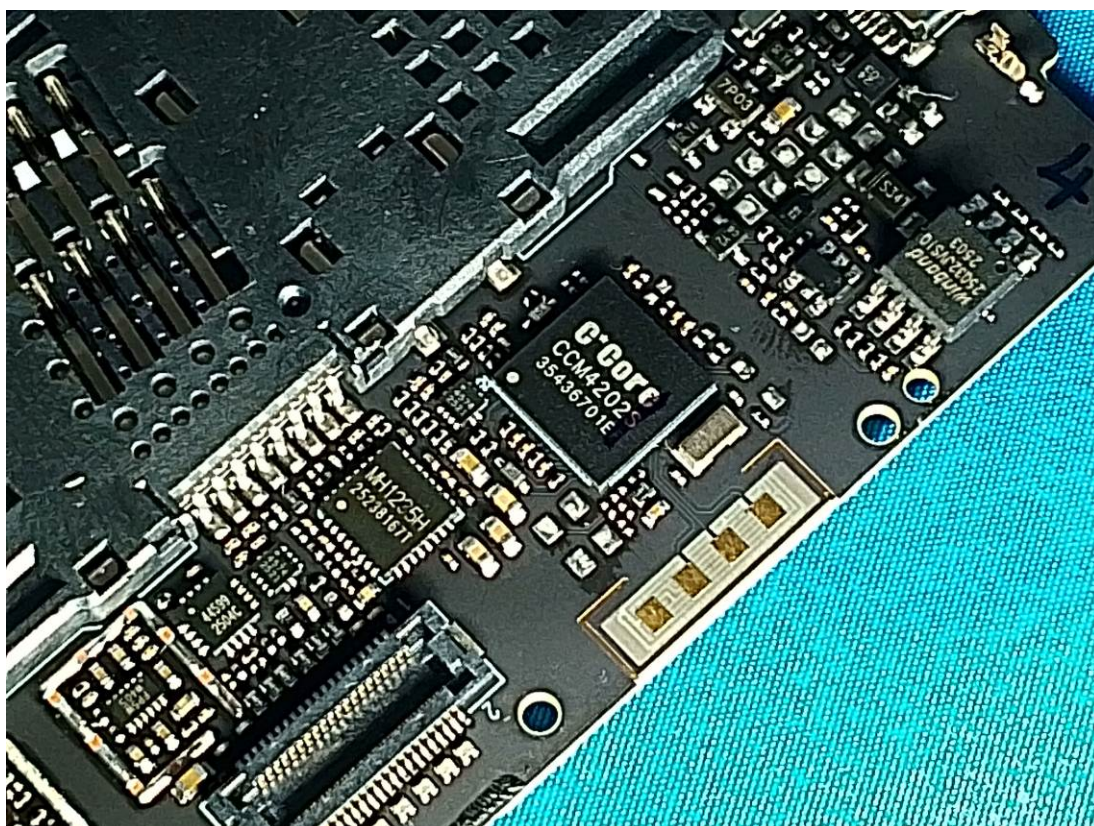


Memory(4GB)

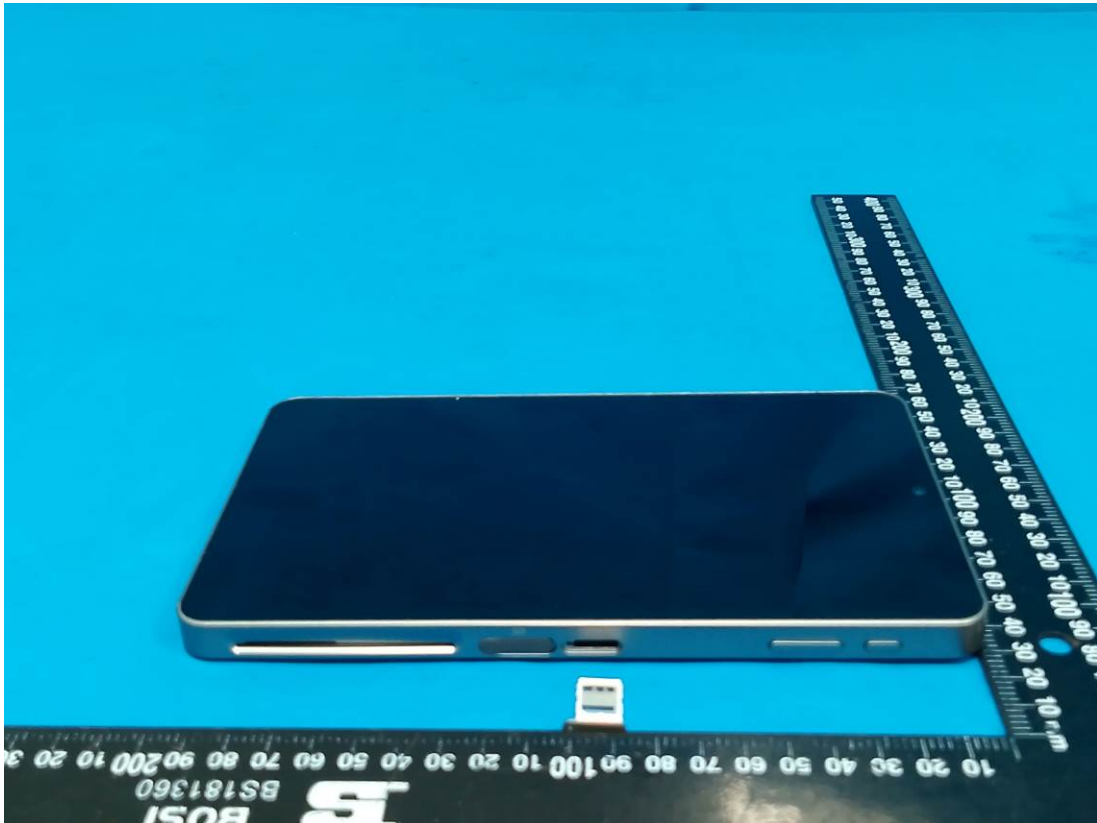
Memory(64GB)



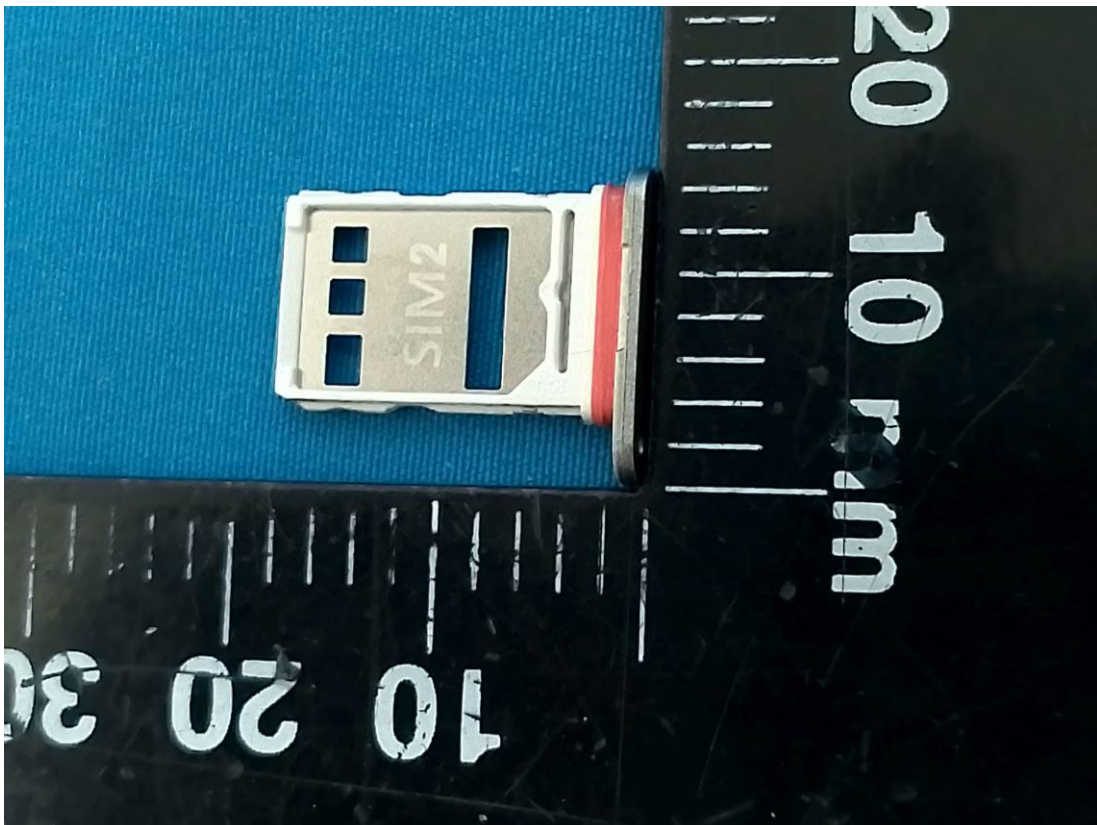
A detailed micrograph of a mobile phone's printed circuit board (PCB). The board is densely packed with various electronic components, including integrated circuits, capacitors, and resistors. Several components are highlighted with red boxes and red arrows. One box points to a small component labeled 'SR'. Another box points to a component labeled '725M61'. A third box points to a component labeled '2R2'. A fourth box points to a component labeled 'R010'. The components are arranged in a grid-like pattern, with some larger components like the '2R2' and 'R010' being more prominent. The PCB is surrounded by a black frame, and there are some white markings on the board.



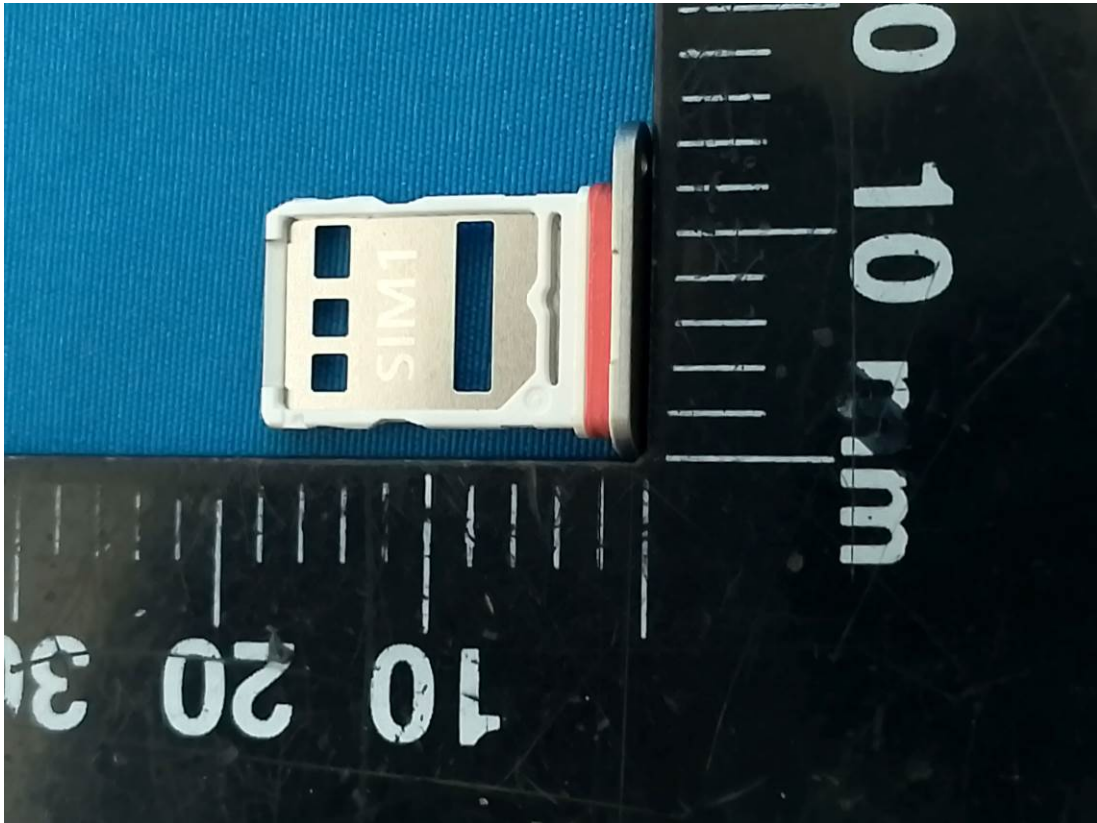
Sample 3#(W6)



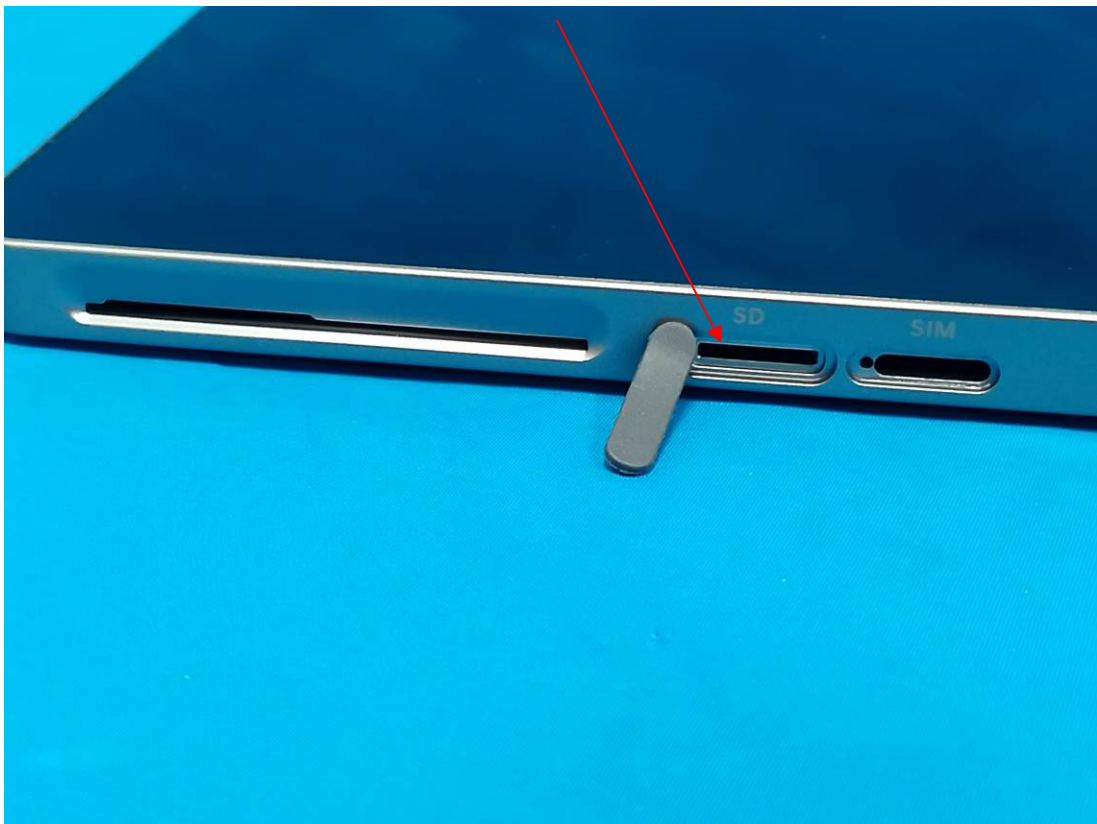
Dual SIM



Dual SIM



SD Card

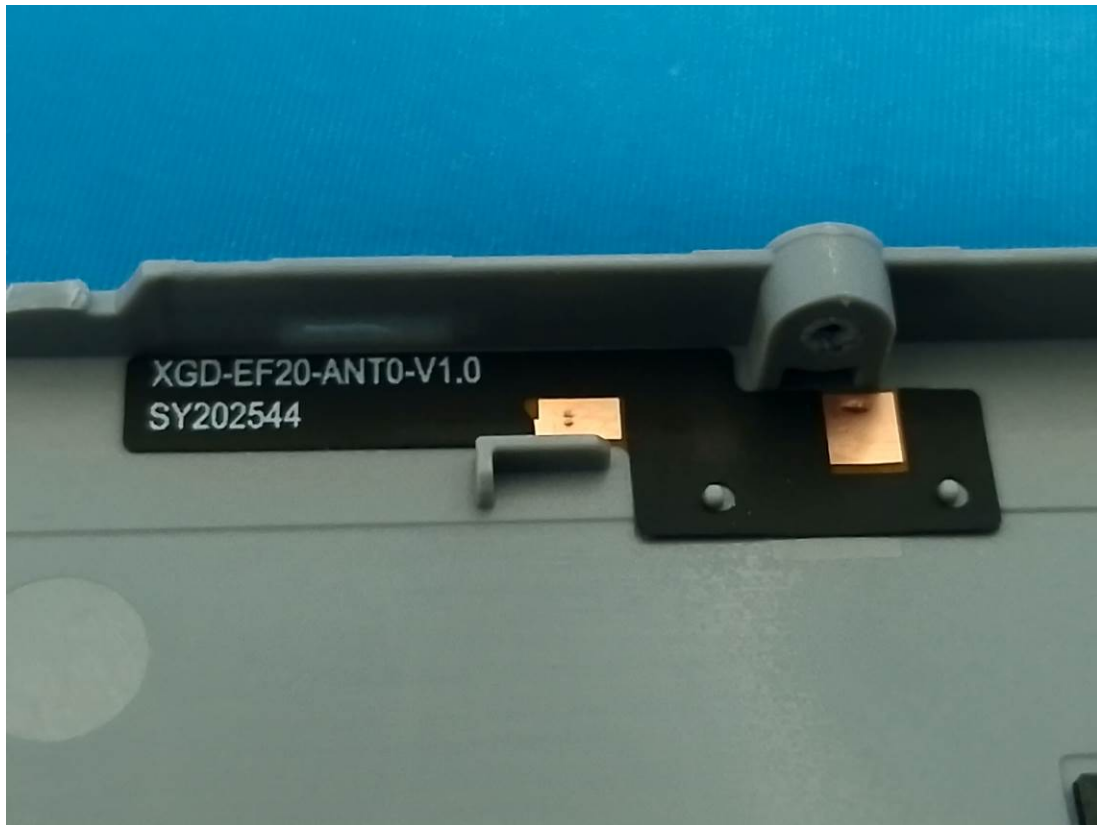




Bluetooth&Wifi Antenna(ANT 2)

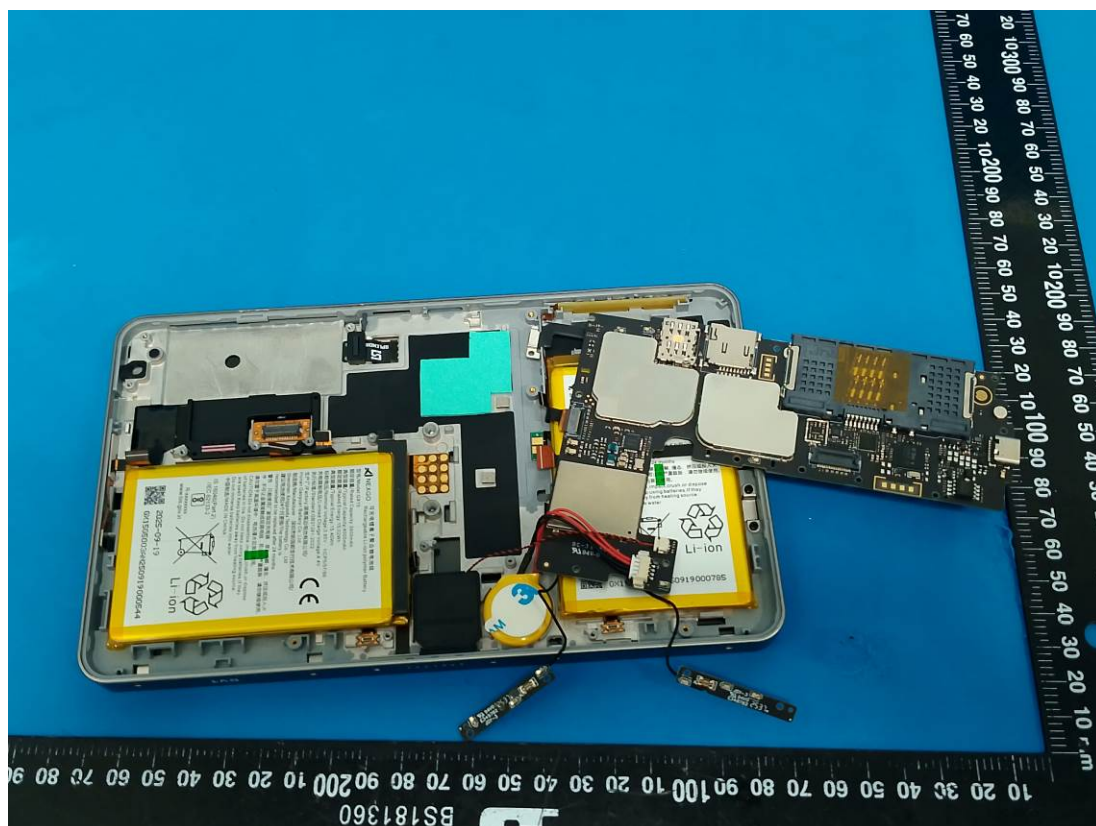


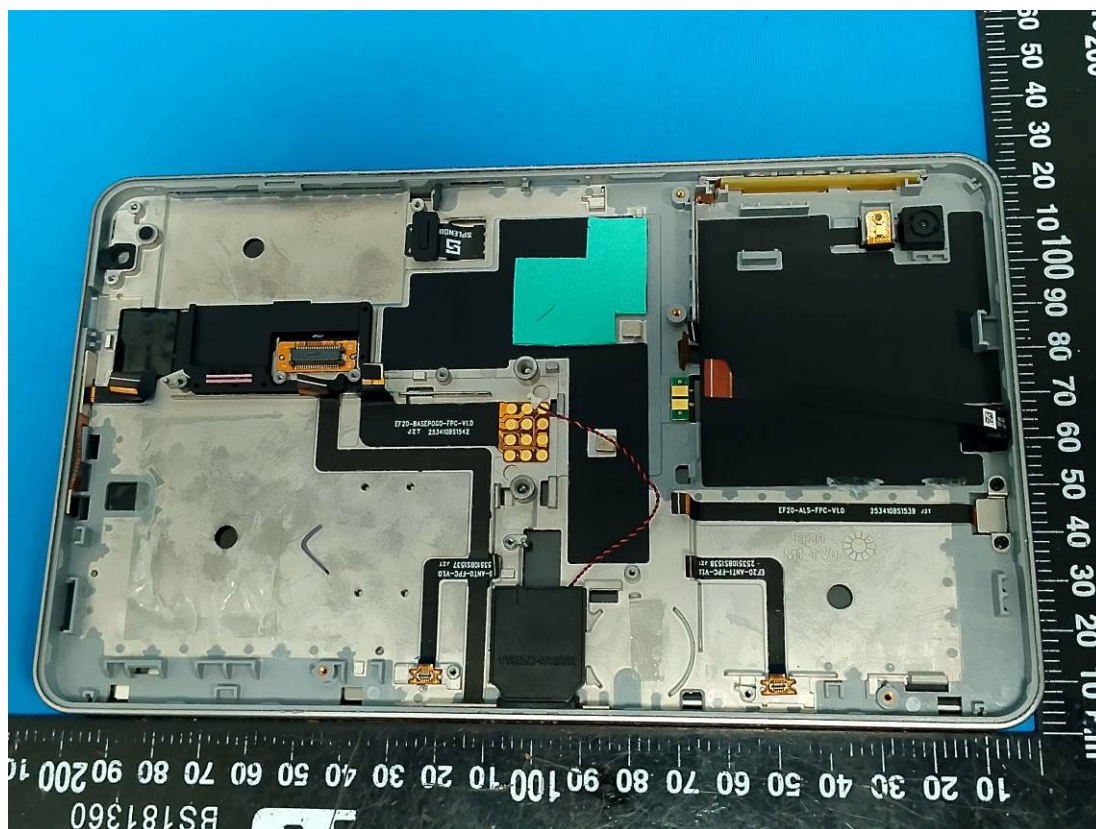
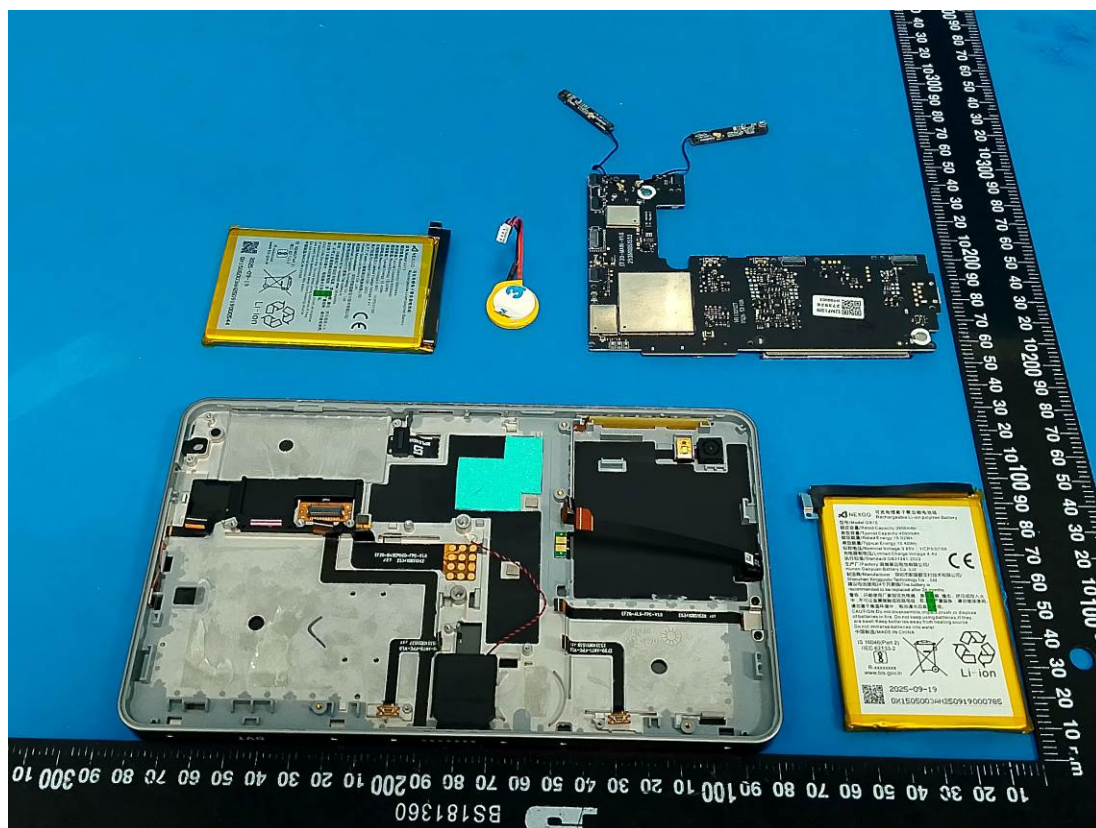
WWAN DIV Antenna(ANT 0)



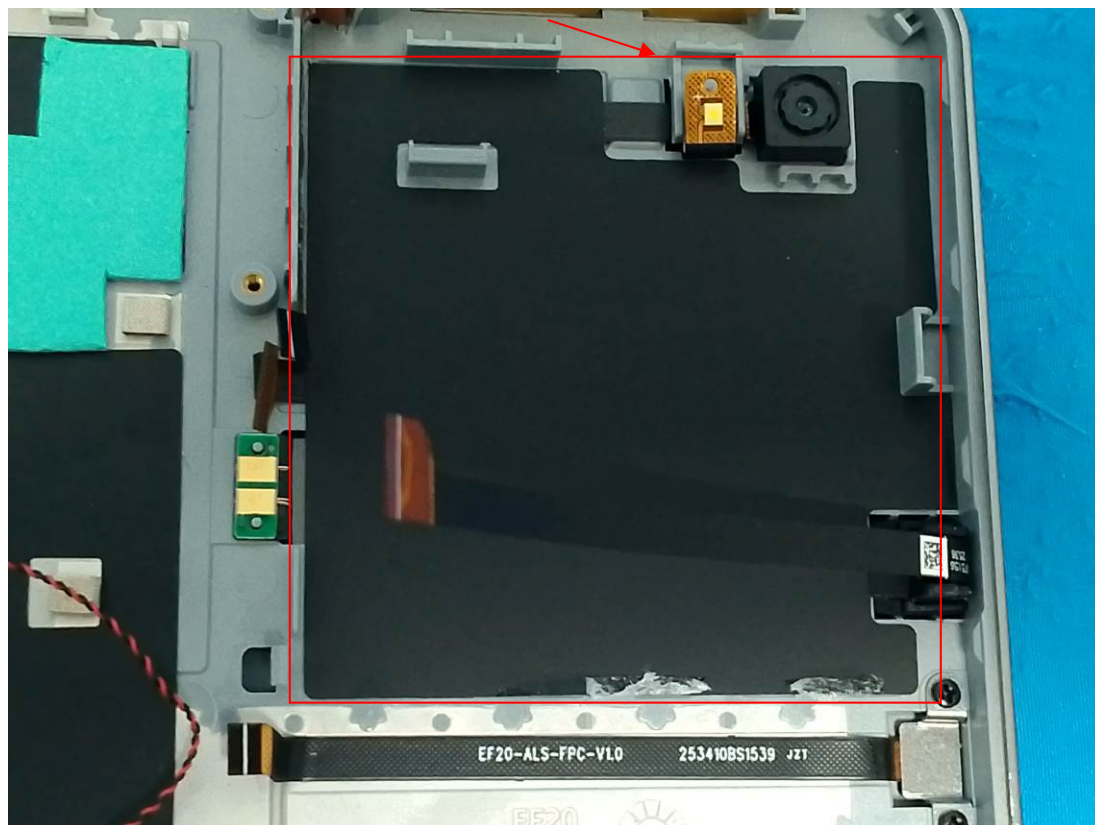
WWAN DIV Antenna(ANT 1)







NFC Antenna(ANT 3)



Dual battery

